

01-25-02

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10/055499
01/22/02

Sir:

Transmitted herewith for filing is the patent application of

Inventor(s): JIN-YUAN LEE;

MOU-SHIUNG LIN;

CHING-CHENG HUANG

For: **INTEGRATED CHIP PACKAGE STRUCTURE USING ORGANIC SUBSTRATE AND METHOD OF MANUFACTURING THE SAME**


Enclosed are:

- (X) Specification in (66) pages.
- (X) 17) sheets of drawings.
- (X) Recordation Form Cover sheet with (2) page assignment.
- (X) **SIGNED** declaration and power of attorney.
- () A certified copy of _____ Patent Application No. _____ dated _____
- (X) **Applicant claims small entity status. See 37 CFR 1.27.**
- (X) Return prepaid postcard.

CLAIMS AS FILED

FOR	NUMBER FILED	NUMBER EXTRA	RATE	FEE
Basic Fee			\$ 370	\$ 370
Total Claims	203 - 20 = 183	×	\$ 9	\$ 1647
Independent Claims	6 - 3 = 3	×	\$ 42	\$ 126
If application contains any multiple dependent claims(s), then add			\$ 140	\$ 0
For a Small Entity:	TOTAL FILING FEE			\$ 2143

- (X) A check in the amount of \$ 2143 to cover the filing fee is enclosed.
- (X) A check in the amount of \$ 40 to cover the assignment recording fee.
- (X) The commissioner is authorized to charge any additional necessary fee to Account No. 50-0710 (Order No. JCLA8534). A duplicate copy of this sheet is enclosed.


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Assistant Commissioner for Patents
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CERTIFICATE OF MAILING BY "EXPRESS MAIL"

Docket No. : JCLA8534
Inventor(s) : JIN-YUAN LEE ;
MOU-SHIUNG LIN;
CHING-CHENG HUANG
For : INTEGRATED CHIP PACKAGE STRUCTURE USING
ORGANIC SUBSTRATE AND METHOD OF
MANUFACTURING THE SAME
"Express Mail"
Mailing Label No. : EV 016848593 US
Date of Deposit : January 22, 2002

I hereby certify that the accompanying

Transmittal in Duplicate; Specification in 66 page(s); 17 Pages of Drawings;
SIGNED Declaration and Power of Attorney in 2 page(s); Assignment and
Recordation Cover Sheet in 3 pages; Checks for Filing Fee(s); Return Prepaid
Postcard

are being deposited with the United States Postal Service "Express Mail Post Office to Addressee"
service under 37 CFR 1.10 on the date indicated above and are addressed to the Assistant
Commissioner for Patents, Washington, D.C. 20231.



Michelle Chang